

TOSHIBA Transistor Silicon PNP Epitaxial Type (PCT Process) (Bias Resistor built-in Transistor)

# RN2707, RN2708, RN2709

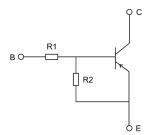
### 1. Applications

- Switching
- Inverter Circuit
- Interface Circuit
- Driver Circuit

### 2. Features

- Including two devices in USV (ultra super mini type with 5 leads)
- With built-in bias resistors
- Simplify circuit design
- Reduce a quantity of parts and manufacturing process and miniaturize equipment.
- Various resistance values are available to suit various circuit designs.
- Complementary to RN1707 to RN1709

### 3. Equivalent Circuit and Bias Resistor Values

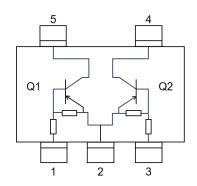


Par	t No.	R1 (kΩ)	R2 (kΩ)		
RN	2707	10	47		
RN:	2708	22	47		
RN:	2709	47	22		

# Unit: mm 2.1±0.1 1.25±0.1 1.0+200 1. BASE 1 (B1) 2. EMITTER (E) 3. BASE 2 (B2) 4. COLLECTOR 2 (C2) 5. COLLECTOR 1 (C1) USV JEDEC — JEITA — TOSHIBA —

Weight: 6.2 mg (typ.)

### 4. Equivalent Circuit (Top View)



Start of commercial production 1998-02



## 5. Absolute Maximum Ratings (Note) (Ta = 25 °C) (Q1, Q2 Common)

Characterist	Symbol	Rating	Unit		
Collector-base voltage	RN2707 to 2709	V <sub>CBO</sub>	-50	V	
Collector-emitter voltage	RN2707 to 2709	VCEO	-50	V	
	RN2707		-6	V	
Emitter-base voltage	RN2708	V <sub>EBO</sub>	-7		
	RN2709		-15		
Collector current		Ic	-100	mA	
Collector power dissipation	RN2707 to 2709	Pc (Note 1)		mW	
Junction temperature	101 10 2709	Tj	150	°C	
Storage temperature range		T <sub>stg</sub>	−55 to 150	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Total rating.

### 6. Electrical Characteristics (Ta = 25 °C) (Q1, Q2 Common)

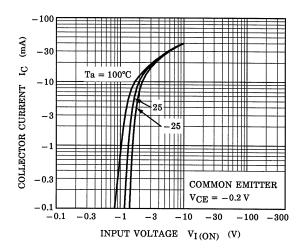
Characteristics		Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit
Collector cut-off current	DN12707 to 2700	I <sub>CBO</sub>	_	$V_{CB} = -50 \text{ V}, I_{E} = 0 \text{ mA}$	_	_	-100	nA
	RN2707 to 2709	ICEO	_	V <sub>CE</sub> = −50 V, I <sub>B</sub> = 0 mA	_	_	-500	nA
Emitter cut-off current	RN2707	I <sub>EBO</sub>	_	V <sub>EB</sub> = -6 V, I <sub>C</sub> = 0 mA	-0.081	_	-0.15	mA
	RN2708		_	V <sub>EB</sub> = -7 V, I <sub>C</sub> = 0 mA	-0.078	_	-0.145	
	RN2709		_	V <sub>EB</sub> = −15 V, I <sub>C</sub> = 0 mA	-0.167	_	-0.311	
	RN2707		_		80	_	_	
DC current gain	RN2708	hFE	_	$V_{CE} = -5 \text{ V, I}_{C} = -10 \text{ mA}$	80	_	_	_
	RN2709		_		70	_	_	
Collector-emitter saturation voltage	RN2707 to 2709	V <sub>CE(sat)</sub>	_	I <sub>C</sub> = -5 mA, I <sub>B</sub> = -0.25 mA	_	-0.1	-0.3	V
Input voltage (ON)	RN2707	V <sub>I(ON)</sub>	_	V <sub>CE</sub> = -0.2 V, I <sub>C</sub> = -5 mA -1.0	-0.7	_	-1.8	V
	RN2708		_		-1.0	_	-2.6	
	RN2709		_		_	-5.8		
	RN2707		_		-0.5	_	-1.0	
Input voltage (OFF)	RN2708	V <sub>I(OFF)</sub>	_	$V_{CE} = -5 \text{ V, I}_{C} = -0.1 \text{ mA}$	-0.6	_	-1.16	V
	RN2709		_		-1.5	_	-2.6	
Transition frequency	RN2707 to 2709	f <sub>T</sub>	_	V <sub>CE</sub> = −10 V, I <sub>C</sub> = −5 mA	_	200	_	MHz
Collector output capacitance	RN2707 to 2709	C <sub>ob</sub>	_	V <sub>CB</sub> = -10 V, I <sub>E</sub> = 0 mA, f = 1 MHz	_	3	6	pF
	RN2707	R1	_	_	7	10	13	kΩ
Input resistor	RN2708		_		15.4	22	28.6	
	RN2709		_		32.9	47	61.1	
	RN2707	R1 / R2	_	_	0.191	0.213	0.232	_
Resistor ratio	RN2708		_		0.421	0.468	0.515	
	RN2709		_		1.92	2.14	2.35	



-0.1

-0.3

### 7. Characteristics Curves (Note) (Q1, Q2 Common)



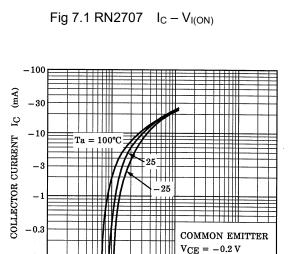


Fig 7.3 RN2708  $I_C - V_{I(ON)}$ 

INPUT VOLTAGE  $V_{I(ON)}$  (V)

-100 -300

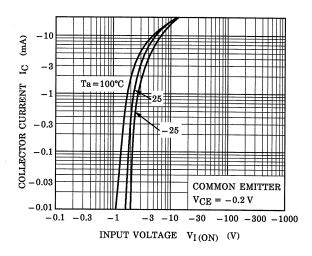


Fig 7.5 RN2709  $I_C - V_{I(ON)}$ 

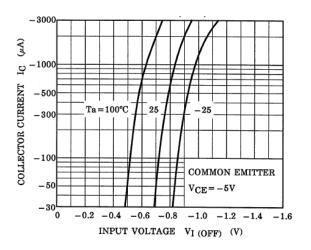


Fig 7.2 RN2707 I<sub>C</sub> - V<sub>I(OFF)</sub>

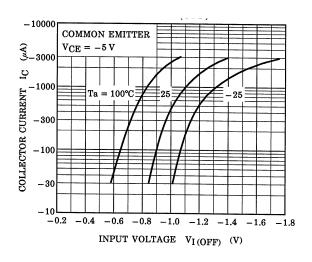


Fig 7.4 RN2708  $I_C - V_{I(OFF)}$ 

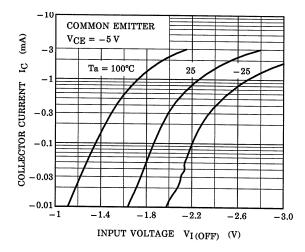


Fig 7.6 RN2709  $I_C - V_{I(OFF)}$ 



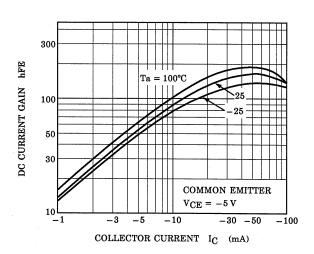


Fig 7.7 RN2707  $h_{FE} - I_C$ 

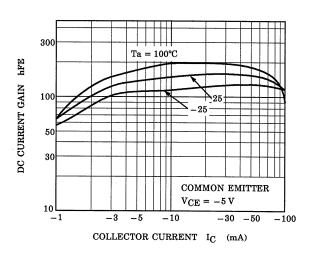


Fig 7.8 RN2708  $h_{FE} - I_C$ 

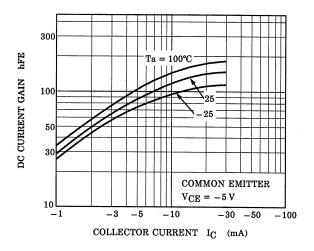


Fig 7.9 RN2709  $h_{FE} - I_C$ 

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



# 8. Marking

Part No.	Marking
RN2707	Part No.(abbreviation code)  Y H
RN2708	Part No.(abbreviation code)
RN2709	Part No.(abbreviation code)



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